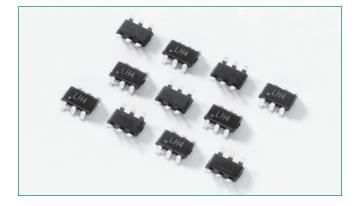
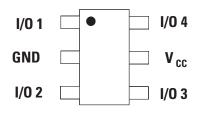


TVS Diode Arrays (SPA[®] Diodes) Low Capacitance ESD Protection - SRV05

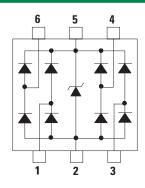
SRV05 Series 6V 10A Diode Array



Pinout



Functional Block Diagram



Additional Information







Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

Description

The SRV05 integrates low capacitance rail-to-rail diodes with an additional zener diode to protect each I/O pin against ESD and high surge events. This robust device can safely absorb surge current per IEC61000-4-5 ($t_p=8/20\mu s$) without performance degradation and a minimum $\pm 20kV$ ESD per IEC61000-4-2. Their very low loading capacitance also makes them ideal for protecting high speed signal pins.

Features

- AEC-Q101 qualified
- ESD, IEC 61000-4-2, ±20kV contact, ±30kV air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Lightning, IEC 61000-4-5 (2nd Edition), 10A (8/20µs)

Applications

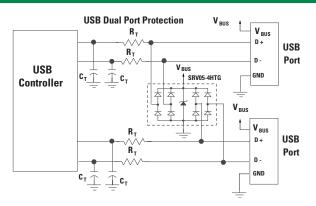
- LCD/PDPTVs
- Monitors
- Notebooks
- 10/100/1000 Ethernet

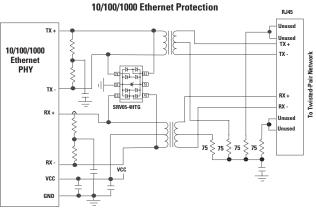
 Low capacitance of 2pF (TYP) per I/O

RoHS 🕫 GREEN

- Low leakage current of 0.5µA (MAX) at 5V
- Small SOT23-6 (JEDEC MO-178) packaging
- Firewire
- Set Top Boxes
- Flat Panel Displays
- Portable Medical

Application Examples





Absolute Maximum Ratings

Symbol	Parameter	Value	Units
l _{pp}	Peak Current (t _p =8/20µs) ¹	10	А
Р _{рк}	Peak Pulse Power (t _p =8/20µs)	150	W
T _{op}	Operating Temperature	-40 to 125	°C
T	Storage Temperature	–55 to 150	°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. 1. Non-repetitive pulse per waveform on page 3

Thermal Information

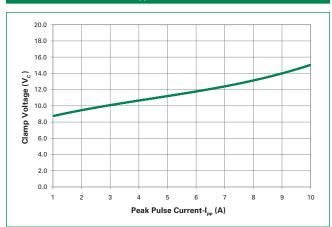
Parameter	Rating	Units
Storage Temperature Range	–55 to 150	°C
Maximum Junction Temperature	150	°C
Maximum Lead Temperature (Soldering 20-40s)	260	°C

Parameter	Symbol	Test Conditions	Min	Тур	Мах	Units
Reverse Standoff Voltage	V _{RVM}	$I_R \le 1\mu A$			6.0	V
Reverse Voltage Drop	V _R	I _R = 1mA		8.0		V
Reverse Leakage Current	I _{LEAK}	V _R =5V		0.1	0.5	μA
	V _c	I_{pp} =1A, t_p =8/20µs, I/O to GND ²		8.8	10.0	V
Clamp Voltage ¹		I_{pp} =5A, t _p =8/20µs, I/O to GND ²		11.5	13.0	V
		I_{pp} =8A, t_p =8/20µs, I/O to GND ²		13.2	15.0	V
Dynamic Resistance	R _{DYN}	(V _{C2} - V _{C1}) / (I _{PP2} - I _{PP1})		0.7		Ω
CCD \//ithotopd \/oltopol		IEC61000-4-2 (Contact)	±20			kV
ESD Withstand Voltage ¹	V _{ESD}	IEC61000-4-2 (Air)	±30			kV
Diada Canasitanas1	C _{I/O-GND}	Reverse Bias=0V		2.4	3.0	pF
Diode Capacitance ¹		Reverse Bias=1.65V		2.0		pF
Diode Capacitance ¹	C _{I/O-I/O}	Reverse Bias=0V		1.2		pF

Notes: 1. Parameter is guaranteed by design and/or device characterization.

2. Repetitive pulse per waveform on page 3.

Clamping Voltage vs. I



Product Characteristics

Lead Plating	Matte Tin		
Lead Material	Copper Alloy		
Lead Coplanarity	0.0004 inches (0.102mm)		
Substitute Material	Silicon		
Body Material	Molded Epoxy		
Flammability	UL 94 V-0		

Notes :

1. All dimensions are in millimeters

Dimensions include solder plating.
Dimensions are exclusive of mold flash & metal burr.

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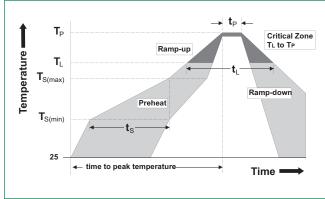
5. Package surface matte finish VDI 11-13.



Capacitance vs. Reverse Bias 3.0 2.5 V_{cc}=Float 2.0 (DE) 2.1 1.5 1.0 V_{cc} =3.3V V_{cc} =5V 0.5 0.0 0.0 0.5 1.0 1.5 2.0 2.5 3.0 3.5 4.0 4.5 5.0 DC Bias (V)

Soldering Parameters

Reflow Cond	Pb – Free assembly		
Pre Heat	- Temperature Min (T _{s(min)})	150°C	
	-Temperature Max (T _{s(max)})	200°C	
	-Time (min to max) (t _s)	60 – 180 secs	
Average ram	3°C/second max		
$T_{S(max)}$ to T_{L} -	3°C/second max		
Reflow	- Temperature (T _L) (Liquidus)	217°C	
nenow	- Temperature (t _L)	60 – 150 seconds	
Peak Temperature (T _p)		260+0/-5 °C	
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T _p)		8 minutes Max.	
Do not exceed		260°C	



Part Numbering System SRV05 - 4 H T G **G=** Green T= Tape & Reel Series Package H: SOT23-6 Number of

Channels

	Assembly Site (Varies)					
Ordering Information						
Part Number	Package	Marking	Min. Order Qty.			
SRV05-4HTG	SOT23-6	L*4	3000			

Product Series

L = SRV05

L * 4

Number of Channels

Pulse Waveform 110% 100% 90% 80% 70% 60% 50% 40% 30% 20%

15.0

Time (µs)

20.0

25.0

30.0

10.0

Part Marking System

L*4

Percent of I_{PP}

10%

0%

0.0

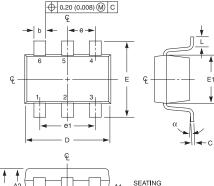
5.0

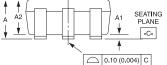


TVS Diode Arrays (SPA® Diodes)

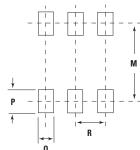
Low Capacitance ESD Protection - SRV05

Package Dimensions - SOT23-6





Recommended Solder Pad Layout



Package			SOT23-6		
Pins	6 MO-178				
JEDEC					
Combal	Millimeters		Inches		Notes
Symbol	Min	Max	Min	Max	Notes
Α	0.900	1.450	0.035	0.057	-
A1	0.000	0.150	0.000	0.006	-
A2	0.900	1.300	0.035	0.051	-
b	0.350	0.500	0.0138	0.0196	-
С	0.080	0.220	0.0031	0.009	-
D	2.800	3.000	0.11	0.118	3
E	2.600	3.000	0.102	0.118	-
E1	1.500	1.750	0.06	0.069	3
е	0.95 Ref		0.0374 ref		-
e1	1.9 Ref		0.074	8 Ref	-
L	0.100	0.600	0.004	0.023	4,5
N	6		6		6
а	0°	10°	0°	10°	-
М		2.590		0.102	-
0		0.690		.027 TYP	-
Р		0.990		.039 TYP	-
R		0.950		0.038	-

Notes:

1. Dimensioning and tolerances per ANSI 14.5M-1982.

2. Package conforms to EIAJ SC-74 (1992).

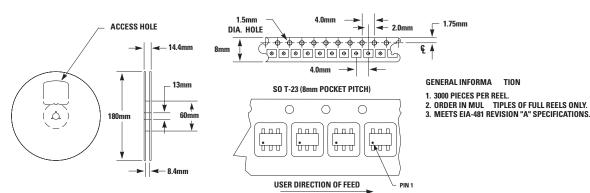
3. Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs.

4. Footlenth L measured at reference to seating plane. 5. "L" is the length of flat foot surface for soldering to substrate.

6. "N" is the number of terminal positions.

7. Controling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

Embossed Carrier Tape & Reel Specification – SOT23-6



8mm TAPE AND REEL

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